

APB3025ESGC-F01

3.0 x 2.5 mm Surface Mount LED Lamp



DESCRIPTIONS

- The High Efficiency Red source color devices are Made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode
- The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode

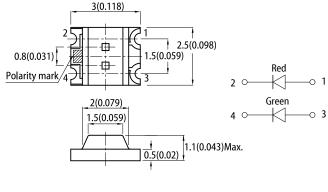
FEATURES

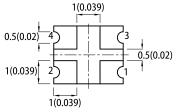
- 3.0 mm x 2.5 mm SMD LED, 1.1 mm thickness
- Bi -color, low power consumption
- · Wide viewing angle
- · Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

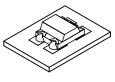
APPLICATIONS

- Backlight
- Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

PACKAGE DIMENSIONS

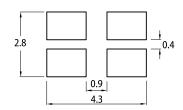






RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.2(0.008") unless otherwise noted.

The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color		lv (mcd) @ 20mA ^[2]		Viewing Angle [1]	
Fait Nulliger	(Material)	Lens Type	Min.	Тур.	201/2	
	High Efficiency Red (GaAsP/GaP)	- Water Clear	8	15		
			*3	*8	400	
APB3025ESGC-F01	Super Bright Green (GaP)		8	15	160°	
			*8	*15		

Notes

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.
* Luminous intensity value is traceable to CIE127-2007 standards.

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value		
			Тур.	Max.	Unit
Wavelength at Peak Emission I_F = 20mA	λ_{peak}	High Efficiency Red Super Bright Green	627 565	-	nm
Dominant Wavelength I _F = 20mA	λ_{dom} ^[1]	High Efficiency Red Super Bright Green	617 568	-	nm
Spectral Bandwidth at 50% Φ REL MAX $I_{\rm F}$ = 20mA	Δλ	High Efficiency Red Super Bright Green	45 30	-	nm
Capacitance	С	High Efficiency Red Super Bright Green	15 15	-	pF
Forward Voltage I _F = 20mA	V _F ^[2]	High Efficiency Red Super Bright Green	2 2.2	2.5 2.5	V
Reverse Current ($V_R = 5V$)	I _R	High Efficiency Red Super Bright Green	-	10 10	μΑ
Temperature Coefficient of λ_{peak} I_F = 20mA, -10°C $\leq T \leq 85°C$	TC_{\lambdapeak}	High Efficiency Red Super Bright Green	0.13 0.12	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 20mA, -10°C $\leq T \leq 85°C$	TC _{λdom}	High Efficiency Red Super Bright Green	0.06 0.08	-	nm/°C
Temperature Coefficient of V_F I_F = 20mA, -10°C \leq T \leq 85°C	TCv	High Efficiency Red Super Bright Green	-1.9 -2	-	mV/°C

Notes:

noies. 1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.) 2. Forward voltage: ±0.1V. 3. Wavelength value is traceable to CIE127-2007 standards. 4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

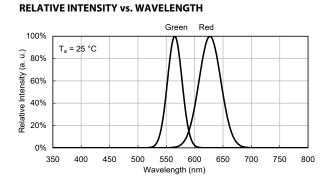
Parameter	Currence al	Value		
Parameter	Symbol	High Efficiency Red	Super Bright Green	– Unit
Power Dissipation	PD	75	62.5	mW
Reverse Voltage	V _R	5	5	V
Junction Temperature	TJ	125	110	°C
Operating Temperature	T _{op}	-40 To +85		
Storage Temperature	T _{stg}	-40 To +85		
DC Forward Current	I _F	30	25	mA
Peak Forward Current	I _{FM} ^[1]	160	140	mA
Electrostatic Discharge Threshold (HBM)	-	8000	8000	V
Thermal Resistance (Junction / Ambient)	R _{th JA} ^[2]	680	710	°C/W
Thermal Resistance (Junction / Solder point)	R _{th JS} ^[2]	510	570	°C/W

Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. R_{th. u.s}, R_{m. u.s} Results from mounting on PC board FR4 (pad size ≥ 16 mm² per pad). 3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

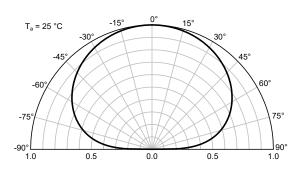
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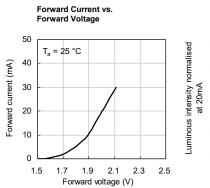
TECHNICAL DATA



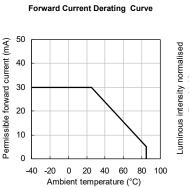
SPATIAL DISTRIBUTION



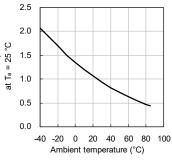
HIGH EFFICIENCY RED

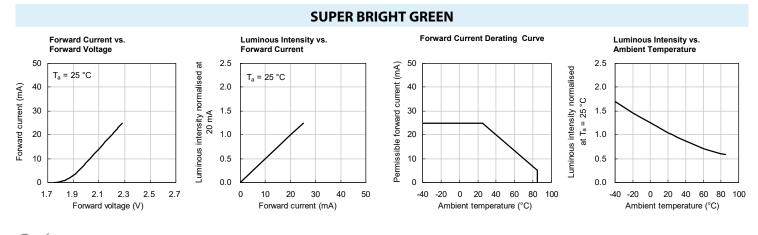


Luminous Intensity vs. Forward Current





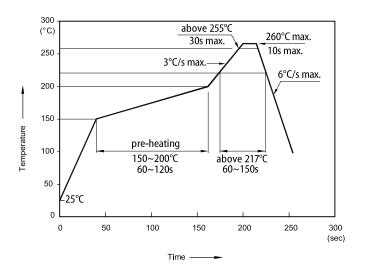




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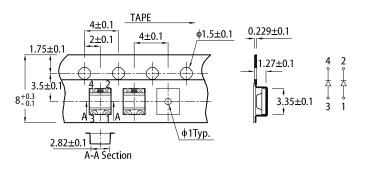
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REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



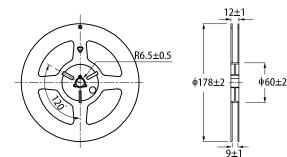
Cont cause stress to the LEDs while it is exposed to high temperature.
The maximum number of reflow soldering passes is 2 times.
Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

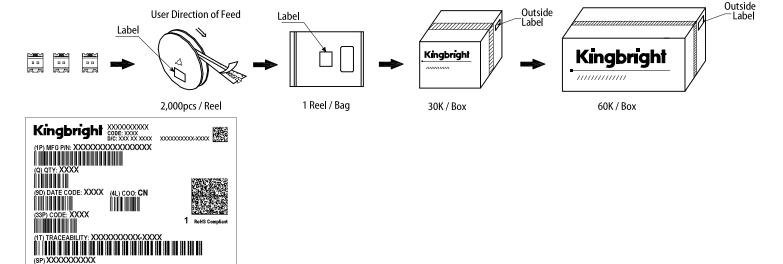
PACKING & LABEL SPECIFICATIONS



REEL DIMENSION (units : mm)

TAPE SPECIFICATIONS (units : mm)





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer 2 to the latest datasheet for the updated specifications.
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